

# OPERATING INSTRUCTIONS 

ALTEC 771B and 771BX Electronic Crossover Biamplifiers improve power handling and reduce distortion without requiring a high-power amplifier and separate crossover network.

## FEATURES:

Electronic Crossover with Separate Power Amplifiers

Heavy LF Demands Do Not Affect HF Performance

Full Amplifier Power and Efficiency

Versatile Input Connections

[^0]Export Model

These ALTEC biamplifiers include electronic crossover circuitry and separate low-frequency (LF) and high-frequency (HF) amplifiers in a single, compact package that can be mounted directly in the speaker enclosure. The electronic crossover circuit divides the input signal into separate bass and treble channels. A 60-watt LF amplifier drives the bass speaker and a 30-watt HF amplifier drives the horn-loaded compression driver.

Extreme LF power demand does not affect HF reproduction because separate amplifiers drive the LF and HF speakers.

The electronic crossover is placed ahead of the dual power amplifiers so that full biamplifier output is distributed to the speakers.

Standard input connections are direct coupled. Transformer isolation of the input is accomplished with an optional plug-in transformer. Input interconnection phono jacks (771B only) permit connecting up to 20 biamplifiers into a single sound system.

ALTEC's Active Dissipation Sensing Circuit provides fail-safe protection for the output transistors. The action of the sensing circuit is immediate and effective at all frequencies within the passband of the biamplifier, limiting only that portion of the program material that would damage or degrade the performance of the output transistors.

The ALTEC 771BX Biamplifier (export model) is similar to the 771B , except that voltage selection and fusing is provided for primary power. The jack for connecting two or more biamplifiers into multiple systems is not provided.


| Graphics | Page |
| :---: | :---: |
| 771B Cover Photograph | 1 |
| Table 1. Operating Controls and Features . . | 4 |
| Figure No. |  |
| 1. Controls and Features . | 5 |
| 2. Speaker Hookup and 771B Interconnections. | 6 |
| 3. Biamplifier Interior . . . . . | 8 |
| 4. Typical Solid-State Component Configurations | 9 |
| 5. Power Transistor Installation. | 10 |
| 6. Schematic, 771B Electronic Crossover Biamplifier | 11 |
| 7. Schematic, 771BX Electronic Crossover Baimplifier | 12 |
| 8. Electronic Part Locations, LF Power Driver PCB Assembly | 13 |
| 9. Schematic, LF Power Driver PCB Assembly | 13 |
| 10. Electronic Part Locations, HF Power Driver PCB Assembly | 14 |
| 11. Schematic, HF Power Driver PCB Assembly | 14 |
| 12. Electronic Part Locations, Crossover PCB Assembly . | 15 |
| 13. Schematic, Crossover PCB Assembly | 15 |

## SPECIFICATIONS

| Type: | Biamplifier with electronic crossover |
| :---: | :---: |
| Gain (with Full Boost) - <br> Bass Amplifier: |  |
|  | 52 dB with 15356 Line Matching Transformer |
|  | 66 dB with 15095 Line Matching Transformer |
| Treble Amplifier: | 49 dB with 15356 Line Matching Transformer |
|  | 63 dB with 15095 Line Matching Transformer |
| Input Sensitivity | 0.5V rms direct |
| (for Rated Output | 0.5V rms with 15356 Line Match- |
|  | ing Transformer (high-level bal-anced-line matched input) |
|  | $0.1 V$ rms with 15095 Line Matching Transformer (high-level bal-anced-line matched input) |
| Power Output Bass Amplifier: Treble Amplifier: |  |
|  | 60 watts at less than 0.5\% THD |
|  | 30 watts at less than 0.5\% THD |
| Total Harmonic Distortion (THD): | Less than $0.5 \%$ at rated power, 20 Hz to 20 kHz |
| IM Distortion: | Unmeasurable by normal IHF method |
| Crossover Frequency: | 500,800 or 1500 Hz with $-12 \mathrm{~dB} /$ octave slope |
| Frequency <br> Response: | $\pm 1 \mathrm{~dB}$ from 20 Hz to 20 kHz (normalized composite output) |
| Input Impedance: | 80,000 ohms direct 600 ohms with 15356 or 15095 transformer |
| Load Impedance: | 8 ohms nominal for eachamplifier |
| Damping Factor: | 25 |
| Noise Level: | 80 dB below rated output |
| Controls: | 1 BASS GAIN CONTROL, continuously variable, +6 dB to -15 dB |
|  | 1 TREBLE GAIN CONTROL, continuously variable, to dB to -15 dB |



## OPERATION

## CONTROLS

All normal operating controls and input jacks are located on the front panel (see Figure 1). Descriptions and functions of controls and connections are listed in Table I.

## NORMAL CONTROL SETTINGS

Recommended initial settings of the BASS and TREBLE GAIN CONTROLS are at 0 dB . Adjust sound-system volume at mixer/amplifier or other input device, then use the BASS and TREBLE GAIN CONTROLS to boost or attenuate the low and high frequencies for desired results.

## VENTILATION

Air must circulate freely past the front panel of the biamplifier for best performance. When moving or positioning the speaker enclosure containing the biamplifier, be sure free circulation of air past the heat-dissipating vanes is not restricted by curtains, furniture, walls or other equipment. Allow at least two inches of space in front of the vanes.

## USING INPUT TERMINAL BOARD

The INPUT terminal board (see Table I and Figure 1) permits either direct coupling or transformer isolation of the input. For direct coupling, connect the input leads (shielded conductor recommended) to terminals 1 and 2; terminal 2 is ground. For transformer-isolated

Table 1. Operating Controls and Features

| Item | Name | Function/Description |
| :---: | :---: | :---: |
| 1 | BASS and TREBLE GAIN CONTROL potentiometers | Provide separate control of bass and treble portions of input signal. Each control is continuously variable from to to -15 dB . Raise controls for gain, lower controls for attenuation. Controls are linear, slide-type potentiometer. |
| 2 | FROM MIXER PREAMPLIFIER jack | Connects (direct coupling) input signal from mixer, preamplifier or other input device. Model 771B can accept an input signal from another 771B (or 771A). |
| 3 | INPUT terminal board | Provides alternate direct coupling of input signal. Transformer isolation of input signal may be obtained when an optional ALTEC plug-in transformer accessory is used. |
| 4 | TO ADDITIONAL POWER SPEAKER jack | Connects another 771 B in parallel to enlarge the sound system. |
| 5 | POWER switch | Applies primary power. Pilot light in switch (771B only) is lit when power is on. |
| 6 | $\begin{array}{\|l\|} \hline \begin{array}{l} \text { PRESS TO } \end{array} \\ \text { RESET } \\ \text { pushbutton } \\ \hline \end{array}$ | Restores primary power if protective circuit breaker is open (771B only). If circuit breaker opens repeatedly, cause should be corrected before resetting. |
| 7 | VOLTAGE SELECT switch | Must be set to appropriate voltage range before turning on amplifier (771BX only). Selects proper transformer primary configuration for line voltages of 95 to $240 \mathrm{~V}, 50 / 60 \mathrm{~Hz}$. <br> CAUTION <br> Turning switch with primary power applied to amplifier may damage or burn out switch. |
| 8 | 30 WATTS - 60 WATTS speaker terminals | Connect HF and LF speakers. Terminals accept push-on connectors without soldering. |
| 9 | ELECTRONIC CROSSOVER FREQUENCY switch | Selects 500,800 or 1500 Hz crossover frequency according to optimum requirements of speaker system. |



Model 771B


Model 771BX


Side and Rear View

Figure 1. Controls and Features
coupling, connect the input leads to terminals 3 and 4 . Transformer-isolated coupling also requires installation of a plug-in ALTEC transformer accessory.

## OPTIONAL PLUG-IN INPUT TRANSFORMER ACCESSORIES

The ALTEC 15356 and 15095 Line Matching Transformers provide a high-level balanced input capability for the biamplifier. The 15356 has a 0.5 V rms input sensitivity for full rated biamplifier output. Input sensitivity with the 15095 is 0.1 V rms for full rated output.

NOTE
THE ALTEC 15356 AND 15095 TRANSFORMERS ARE NOT CUSTOMER SERVICEABLE COMPONENTS AND THEREFORE MUST BE INSTALLED BY AN ALTEC QUALIFIED SERVICE REPRESENTATIVE.

## CONNECTING 771Bs IN MULTIPLE SYSTEMS

Each 771B is provided withan interconnecting cable to combine an additional 771B into the sound system. Up to 20 of the 771 Bs may be connected into a single sound system in this manner. Speaker hookup and parallel multiple-system interconnections are shown in Figure 2. The input signal cable is plugged into the FROM MIXER PREAMPLIFIER jack. The next 771B is connected in parallel byplugging the provided interconnecting cable in to the TO ADDITIONAL POWER SPEAKER jack on the first 771B and into the FROM PREAMPLIFIER jack on the second 771B. Continue this interconnection method to combine as many 771 Bs as required (up to 20 units).


Figure 2. Speaker Hookup and 771B Interconnectios

## INSTALLATION

The 771B and 771BX are designed to be installed at a convenient location in the speaker enclosure. If installation is made in an existing speaker system, the passive crossover network already present in the system must be removed because the biamplifier contains an electronic crossover circuit.

If the biamplifier is to be installed in an enclosure not previously prepared for its installation, complete all steps of the following procedure. If the biamplifier is to be installed in an ALTEC enclosure specifically prepared for it, complete only Steps 5, 6 and 7 of the installation procedure.

Step 1. Cut rectangular hole 5-1/2" high by 9-1/2" wide in enclosure at desired location. Note required depth to accommodate biamplifier is 9".

Step 2. Insert biamplifier in cutout and mark center points for each of six holes to be drilled for securing hardware. Remove biamplifier.

Step 3. Use 7/32" (0.218") to drill and bore holes, located in Step 2, to accept shaft of 8-32" 'T' nuts supplied with biamplifier. Remove debris from enclosure and edges of holes.

Step 4. Insert six ' $T$ ' nuts in mounting holes from inner side of enclosure. Gently hammer each in place until ' $T$ ' nut faces are flush with enclosure surface.

Step 5. Install supplied speaker wires on speakers and biamplifier speaker terminals (s e e Figure 2). Note that minimum speaker impedance is eight ohms.

Step 6. Verify that ELECTRONIC CROSSOVER FREQUENCY switch is set to appropriate 500, 800 or 1500 Hz position, as required by speaker system.

Step 7. Insert biamplifier in cutout and secure it to ${ }^{\prime} T$ ' nuts with six (6) $8-32^{\prime \prime} \times 1-1 / 4$ "screws (supplied).

## SERVICE AND MAINTENANCE INSTRUCTIONS

This service information is for the use of authorized warranty stations (dealers) only. Service must be performed by an ALTEC Qualified Service Representative.


## ACCESS

Remove the eight screws securing the cover to the chass is . Carefully slide cover off, flexing it slightly to clear the screws that attach the speaker terminal bracket.

Installing Plug-In Input Transformer Accessories
Verify line power is turned off, then remove chassis cover. Carefully plug the accessory input transformer into the octal socket (J3) in the chassis (see Figure 3), then replace chass is cover and secure with eight screws previously removed.

## Power Driver Bias Adjustment

Adjustment of the power driver bias control(s) may be required when replacing a power transistor or power driver printed circuit board (PCB). One bias adjusting control is located on each power driver PCB; R12 on the HF power driver PCB and R13 on the LF power driver PCB (see Figures 3 and 9). These controls set the bias for proper crossover between negative and positive signal components of power transistors Q1 and Q2 (HF); Q3 and Q4 (LF) (see Figures 3 and 5). Improper adjustment of these controls results in distortion at the crossover frequency. To adjust either R12 or R13, use the following procedure:
2. If adjusting R12, set a dc VTVM to scale that will conveniently read 20 mV and connect its positive $(+)$ lead to Q1 emitter and its negative (-) lead to Q2 collector (see Figure 4, Motorola MJE).
3. If adjusting R13, set a de VTVM to scale that will conveniently read 20 mV and connect its positive $(+)$ lead to Q3 emitter and its negative (-) lead to Q4 collector (see Figure 4, Motorola MJE).
4. Turn on line power to biamplifier.
5. Observe VTVM; it should read approximately 17.5 mV .
6. Adjust bias control (R12 or R13), as necessary (see Figure 3). Clockwise adjustment increases voltage, counterclockwise adjustment decreases voltage.
7. Allow stabilization 15 to 30 minutes for drift check. If dc voltage reading changes more than $\pm 15 \mathrm{mV}$, readjust bias control for 17.5 mV .
8. Turn off line power, disconnect VTVM, replace chassis cover and secure with eight screws previously removed.

1. Verify line power is turned off, then remove chassis cover.


Figure 3. Biamplifier Interior

PCB Replacement
A crossover PCB and two power driver PCBs are located within the chassis (see Figures 3 and 6). Use the following procedure to replace a failed PCB with a new or repaired PCB.

1. Verify line power is turned off, then remove chassis cover.
2. If a power driver PCB is being replaced, carefully remove cable connector from jack on PCB.
3. Carefully remove PCB from standoffs, loosening evenly at each corner.

CAUTION
Do not warp, bend or twist the board or conductor may fracture.
4. Carefully press new or repaired PCB into place on standoffs. Press corners in place evenly until plastic fasteners lock PCB in position.
5. If a power driver PCB is replaced, carefully press cable connector, previously removed, onto jack on PCB. Verify that power driver bias adjustment is correct and readjust if necessary. Refer to Power Driver Bias Adjustment procedure.
6. Replace chassis cover and secure with eight screws previously removed.

## RECOMMENDED SERVICE TECHNIQUES

If systematic troubleshooting shows need for parts replacement, observe the following precaustions.

Transistor Orientation
Solid-state components are packaged in various case sizes and types with various lead orientations (see Figure 4). Before removing a solid-state component from tie points or from a PCB, sketch the lead orientation with respect to the tie points or PCB.

Form the leads of the new component to conform with the leads of the part being replaced to aid in making proper connections.

Before removing small transistors, note position of index tab with respect to the PCB or socket. Cut the leads of the new transistor to the required length and insert them into the PCB or socket properly indexed.

## Replacing Power Transistors

Be sure the following conditions exist when replacing power transistors.


* Not all types. Some have base-to-case internally; others have no connection to case.
G.E. Epoxy


TO-92


Lead E - Emitter
Lead B - Base
Lead C-Collector

## Motorola MJE



Figure 4. Typical Solid-State Component Configurations

1. The mica insulator is not damaged. If damaged, use new insulator.
2. No grit or metal particles are between replacement transistor and heat sink.
3. Both side of mica insulator are covered with silicone grease or fluid.
4. Mounting screws are tight (see Figure 5).

> CAUTION

Install concave washer on power transistor with concave surface DOWN; otherwise, power transistor may fracture.


Figure 5. Power Transistor Installation

## Testing Transistors

Transistors should be checked with a transistor tester. If a tester is not available, use the following procedure for testing transistors with an ohmmeter.

Step 1. Remove suspected transistor from circuit (see Replacing PCB Components).

Step 2. Connect ohmmeter leads to base and emitter. Read on lowest ohms scale. Reverse leads and read again. Normal readings should be at least 10 times greater in one direction than in the other.

Step 3. Connect ohmmeter leads to base and collector and repeat Step 2. Ohmmeter readings should be similar to those obtained in Step 2.

Step 4. If Steps 2 and 3 show normal function, connect ohmmeter leads to collector and emitter. Read on lowest ohms scale. Reverse leads and read again. If reading is low and virtually unchanged when ohmmeter leads are reversed, the transistor has a short circuit between collector and emitter.

## Replacing PCB Components

The main chassis schematic for the 771B is shown in Figure 6 and the main chassis schematic for the 771BX is shown in Figure 7. Component locations on the PCBs are shown in Figures 8, 10 and 12. PCB schematics are shown in Figures 9, 11 and 13. Before removing PCB components for testing or replacement, read and heed the following instructions.

1. Solid-state components and PCBs may be damaged by excessive heat. Use a small soldering iron with a $1 / 8$-inch diameter chisel tip. Use small-diameter, 60/40 rosin-cored solder.
2. Remove components by placing soldering iron on component lead on conductor side of PCB and pull out lead. Avoid overheating the conductor.

CAUTION
The conductor on the PCB is a metal surface plated with solder and laminated to the board. Too much pressure or overheating may lift the conductor from the board.
3. If component is faulty or damaged, clip leads close to component and then unsolder leads from board. Withdraw leads from component side.
4. Clear solder from circuit board holes before inserting leads of new component. Heat solder remaining in hole, remove iron and quickly insert a pointed nonmetallic object, such as a toothpick from conductor side.
5. Shape new component leads and clip to proper length. Lead shape should provide stress relief for component. Insert leads in holes, observing same polarity or orientation of removed component. Apply heat and solder on conductor side.

## Repairing Fractured or Damaged PCB Conductor

If a conductor is fractured, damaged or lifted from the circuit board, a recommended method of repair is to solder a section of good conducting wire along the damaged area and seal with epoxy.
$1 /$ Rec 602


HIGHEST REFERENCE DESGGATION USED

 | S1 | A3 | P3 | F2 |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- |
| REFERENCE DESIGNATIONS NOT USED |  |  |  |  |  |
|  |  |  |  |  |  |



Figure 6. Schematic (3D212-1), 771B Electronic Crossover Biamplifier


Figure 7. Schematic (3D228-1), 771BX Electronic Crossover Biamplifier


Figure 8. Electronic Part Locations (2C573-4), LF Power Driver PCB Assemb!y


Figure 9. Schematic (2D544-7), LF Power Driver PCB Assembly


Figure 10. Electronic Part Locations (2C572-3), HF Power Driver PCB Assembly


Figure 11. Schematic (2D545-4), HF Power Driver PCB Assembly


Figure 12. Electronic Part Locations (3C065-1), Crossover PCB Assembly


Figure 13. Schematic (3C066-2), Crossover PCB Assembly

PARTS LIST

771B/771BX MAIN CHASSIS

| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| Al | 27-01-042638-01 | PCB assembly, cross over |
| A2 | 27-01-042245-01 | PCB assembly, HF power driver |
| A3 | 27-01-042244-01 | PCB assembly, LF power driver |
| Cl | 15-01-100296-01 | Cap., $5000 \mu \mathrm{~F}, 25 \mathrm{~V}$ |
| C2 | 15-01-107511-01 | Cap., $6200 \mu \mathrm{~F}, 75 \mathrm{~V}$ |
| C3 | 15-01-100298-01 | Cap., $5000 \mu \mathrm{~F}, 60 \mathrm{~V}$ |
| C4 | 15-01-100279-01 | Cap., $500 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C5 | 15-01-114352-01 | Cap., $4000 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C6,7 | 15-06-102605-01 | $\begin{aligned} & \text { Cap. , } 0.47 \mu \mathrm{~F} \pm 10 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C8 | 15-02-100089-01 | $\begin{aligned} & \text { Cap. , } 0.01 \mu \mathrm{~F} \pm 20 \% \text {, } \\ & 4000 \mathrm{~V} \end{aligned}$ |
| $\begin{aligned} & \text { CB1 (771B } \\ & \text { only) } \end{aligned}$ | 51-03-109809-02 | Circuit breaker, 2.2A hold, 3.25A trip |
| CR1 | 48-02-108577-01 | Diode bridge rectifier, 1.5A, 100 PIV |
| CR2,3,4,5 | 48-02-107467-01 | Diode, rectifier, 1N5402,200V, 3A |
| CR6,7,9,10 | 48-01-109275-01 | $\begin{aligned} & \text { Diode, Zener, } \\ & 1 \mathrm{~N} 746,3.3 \mathrm{~V} \pm 10 \%, \\ & 400 \mathrm{~mW} \end{aligned}$ |
| CR8,11 | 48-01-107429-01 | Diode, stabistor, 3pellet |
| F1,2 | 51-04-100462-01 | $\left\lvert\, \begin{gathered} \text { Fuse, } 1 / 4 \mathrm{~A}, 3 \mathrm{AG}, \\ 250 \mathrm{~V} \end{gathered}\right.$ |
| $\begin{aligned} & \mathrm{F} 3,4 \text { (771BX } \\ & \text { only) } \end{aligned}$ | 51-04-100464-01 | Fuse, 1A, 3AG |
| J1 | 21-01-114347-01 | Jack |
| $\begin{aligned} & \text { J2 (771B } \\ & \text { only) } \end{aligned}$ | 21-01-114347-01 | Jack |


| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| J3 | 21-02-100973-01 | Socket, octal |
| Q1,2,3,4 | 48-03-109715-02 | Transistor |
| R1,3 | 47-06-042269-02 | Pot., 10K $\Omega, \mathrm{B}$ taper |
| R2,4 | 47-01-102163-01 | $\underset{1 / 4 W}{\text { Res. }} 1 K \Omega \pm 10 \%,$ |
| R5,7 | 47-02-107434-01 | $\begin{aligned} & \text { Res . , } 0.33 \Omega \pm 10 \%, \\ & 3 W \end{aligned}$ |
| R6,8 | 47-02-108238-01 | $\begin{aligned} & \operatorname{Res} ., 0.25 \Omega \pm 10 \%, \\ & 3 W \end{aligned}$ |
| R9, 10 | 47-02-112166-01 | Res., $5 \Omega \pm 10 \%, 5 \mathrm{~W}$ |
| R11,12 <br> (771BX only) | 47-01-102359-01 | $\begin{aligned} & \text { Res., } 2.2 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 2 \mathrm{~W} \end{aligned}$ |
| $\begin{aligned} & \text { R13 (771BX } \\ & \text { only) } \end{aligned}$ | 47-01-102075-01 | $\begin{aligned} & \text { Res., } 750 \Omega \pm 5 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| $\begin{aligned} & \text { Si (77lB } \\ & \text { only) } \end{aligned}$ | 51-02-113986-01 | Switch assembly, DPDT, w/pilot lamp |
| $\begin{aligned} & \text { Si (771BX } \\ & \text { only) } \end{aligned}$ | 51-02-113535-01 | Switch, SPDT, slide |
| $\left\lvert\, \begin{aligned} & \text { S2 (771 } 1 \mathrm{BX} \\ & \text { only) } \\ & \text { ent } \end{aligned}\right.$ | 51-01-042617-01 | Switch, 2-gang, rotary |
| $\begin{aligned} & \mathrm{T} 1 \text { (771B } \\ & \text { only) } \end{aligned}$ | 56-08-007458-01 | Transformer, power |
| $\begin{aligned} & \text { Tl (771BX } \\ & \text { only) } \end{aligned}$ | 56-08-007543-01 | Transformer, power |
| \|TB9 | 21-04-101038-01 | Terminal board, 4terminal, input |
| TB11 | 21-04-030799-01 | Terminal board, 4terminal, speakers |
| W1,2 | 60-09-042284-02 | Cable assembly |

## PARTS LIST (continued)

LF POWER DRIVER PCB ASSEMBLY

| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| Cl | 15-01-107452-01 | Cap., $10 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C2,6,13 | 15-01-100241-01 | Cap., $50 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C3,7 | 15-01-110771-01 | Cap., $5 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C4 | 15-01-107500-01 | Cap., $100 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C5,9,10 | 15-06-108173-01 | $\begin{aligned} & \text { Cap., } 0.47 \mu \mathrm{~F} \pm 20 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C8 | 15-02-107454-01 | $\begin{aligned} & \text { Cap., } 100 \mathrm{pF} \pm 10 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C11,12 | 15-02-100307-01 | $\begin{aligned} & \text { Cap., } 0.01 \mu \mathrm{~F}, \pm 20 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C14 | 15-02-100302-01 | $\begin{aligned} & \text { Cap., } 470 \mathrm{pF} \pm 10 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| CR1,2,3,4,5 | 48-01-107017-01 | Diode, IN456A, $25 \mathrm{~V}, 100 \mathrm{~mA}$ |
| CR6, | 48-01-102592-01 | Diode |
| CR8 | 48-01-110786-01 | Diode, Zener, 23 V $\pm 5 \%, 2 \mathrm{~W}$ |
| $J 1$ | 21-01-109731-01 | Jack, phono |
| Q1,2 | 48-03-110773-01 | Transistor, PNP, 50V |
| Q3,7 | 48-03-107447-02 | Transistor, 2N5320, NPN, 10W, 75V |
| Q4 | 48-03-041440-01 | Transistor, PNP |
| Q5 | 48-03-101098-01 | Transistor, NPN |
| Q6 | 48-03-107448-02 | Transistor, 2N5322, PNP, 10W, 75V |
| R1,9 | 47-01-102178-01 | $\begin{aligned} & \text { Res., } 18 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R2 | 47-01-102181-01 | $\begin{aligned} & \text { Res., } 33 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R3 | 47-01-102116-01 | $\underset{\substack{\text { Res. }, 1 / 4 W}}{ } 39 \mathrm{~K} \Omega \pm 5 \%,$ |
| R4 | 47-01-102155-01 | $\text { Res. , } 220 \Omega \pm 10 \% \text {, }$ $1 / 4 \mathrm{~W}$ |


| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| R5,6 | 47-01-102169-01 | $\begin{aligned} & \text { Res., } 3.3 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R7, 16, 17 |  |  |
| 25,27 | 47-01-102151-01 | $\begin{aligned} & \text { Res., } 100 \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |
| R8 | 47-01-102067-01 | $\begin{aligned} & \text { Res. . } 360 \Omega \pm 5 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R10 | 47-01-102183-01 | $\begin{aligned} & \text { Res., } 47 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R11,12 | 47-01-102359-01 | $\begin{aligned} & \text { Res., } 2.2 \mathrm{~K} \Omega \pm 10 \%, \\ & \mathrm{l} / 2 \mathrm{~W} \end{aligned}$ |
| R13 | 47-05-107504-01 | $\begin{aligned} & \text { Pot . , } 500 \Omega \pm 20 \% \text {, } \\ & 2 W \end{aligned}$ |
| R14 | 47-01-102140-01 | $\underset{\mathrm{Res} ., 1}{\mathrm{R} / 4 \mathrm{~W}}, 10 \Omega \pm 10 \%,$ |
| R15 | 47-01-102147-01 | $\begin{aligned} & \text { Res., } 47 \Omega \pm 10 \% \text {, } \\ & \mathrm{l} / 4 \mathrm{~W} \end{aligned}$ |
| $\begin{gathered} \mathrm{R} 18,19, \\ 20,30 \end{gathered}$ | 47-01-102171-01 | $\begin{aligned} & \text { Res., } 4.7 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R21 | 47-01-102156-01 | $\begin{aligned} & \text { Res., } 270 \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R22,23 | 47-01-102167-01 | $\begin{aligned} & \text { Res., } 2.2 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R24,26 | 47-01-102152-01 | $\begin{aligned} & \text { Res., } 120 \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |
| R29 | 47-01-102157-01 | $\begin{aligned} & \text { Res., } 330 \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |
| R31 | 47-01-000001-01 | Res., value specially selected in test, $\pm 5 \%$, 1/4W |
| R32 | 47-01-102163-01 | $\begin{aligned} & \text { Res., } 1 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |

PARTS LIST (continued)
HF POWER DRIVER PCB ASSEMBLY

| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| Cl | 15-06-100311-01 | $\begin{aligned} & \text { Cap., } 0.1 \mu \mathrm{~F} \pm 20 \% \text {, } \\ & 250 \mathrm{~V} \end{aligned}$ |
| C2,4 | 15-01-107501-01 | Cap., $25 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C3,7 | 15-01-110771-01 | Cap., $5 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C5 | 15-06-108173-01 | $\begin{aligned} & \text { Cap., } 0.47 \mu \mathrm{~F} \pm 20 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C6 | 15-01-100241-01 | Cap., $50 \mu \mathrm{~F} 50 \mathrm{~V}$ |
| C8 | 15-02-107454-01 | $\begin{aligned} & \text { Cap., } 100 \mathrm{pF} \pm 10 \%, \\ & 100 \mathrm{~V} \end{aligned}$ |
| C9 | 15-02-100302-01 | $\begin{aligned} & \text { Cap., } 470 \mathrm{pF} \pm 10 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| CR1,2,3 | 48-01-102592-01 | Diode |
| $J 1$ | 21-01-109731-01 | Jack, phono |
| Q1,2 | 48-03-108557-02 | Transistor, 2N5367, PNP, 0.36W, 40V |
| Q3,7 | 48-03-107447-02 | Transistor, 2N5320, NPN, 10W, 75V |
| Q4 | 48-03-101098-01 | Transistor |
| Q5 | 48-03-041440-01 | Transistor |
| Q6 | 48-03-107448-02 | Transistor, 2N5322, PNP, 10W, 75V |


| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| R1,8 | 47-01-102181-01 | $\begin{aligned} & \text { Res., } 33 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R2,3,14,16 | 47-01-102175-01 | $\begin{aligned} & \text { Res., } 10 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R4 | 47-01-102159-01 | $\begin{aligned} & \text { Res., } 470 \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |
| R5, 6, 15, 17 | 47-01-102169-01 | $\begin{aligned} & \text { Res., } 3.3 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R7,21 | 47-01-102163-01 | $\underset{\substack{\text { Res., } \\ 1 / 4 W}}{ } 1 K \pm \pm 10 \% \text {, }$ |
| R9 | 47-01-102183-01 | $\begin{aligned} & \text { Res., } 47 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R10,11 | 47-01-102359-01 | $\begin{aligned} & \text { Res., } 2.2 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 2 \mathrm{~W} \end{aligned}$ |
| R12 | 47-05-107504-01 | $\begin{aligned} & \mathrm{Po} \mathrm{\dagger} ., 500 \Omega \pm 20 \%, \\ & 2 W \end{aligned}$ |
| R13,20 | 47-01-102156-01 | $\begin{aligned} & \text { Res., } 270 \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R18,19 | 47-01-102151-01 | $\begin{aligned} & \text { Res ., } 100 \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |

## PARTS LIST (continued)

CROSSOVER PCB ASSEMBLY

| Reference Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| C1,2 | 15-01-108543-01 | Cap., $5 \mu \mathrm{~F}, 25 \mathrm{~V}$ |
| C3 | 15-01-100241-01 | Cap., $50 \mu \mathrm{~F}, 50 \mathrm{~V}$ |
| C4,9,10 | 15-01-107495-01 | $\begin{aligned} & \text { Cap., } \\ & 25 \mathrm{~V} \end{aligned}, 25 \mu \mathrm{~F} \pm 10 \%,$ |
| C5 | 15-06-051240-02 | $\begin{aligned} & \text { Cap. , } 0.025 \mu \mathrm{~F} \pm 5 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| C6,7,8 | 15-06-109091-01 | $\begin{aligned} & \text { Cap. , } 0.012 \mu \mathrm{~F} \pm 5 \% \text {, } \\ & 100 \mathrm{~V} \end{aligned}$ |
| Q1,2,3 | 48-03-041627-01 | Transistor |
| R1 | 47-01-100482-01 | $\begin{aligned} & \text { Res., } 1 M \Omega \pm 10 \%, \\ & 1 / 4 W \end{aligned}$ |
| R2,3 | 47-01-102187-01 | $\begin{aligned} & \text { Res., } 100 \mathrm{~K} \Omega \pm 10 \% \text {, } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R4 | 47-01-102191-01 | $\begin{aligned} & \text { Res., } 220 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R5 | 47-01-102169-01 | $\begin{aligned} & \text { Res., } 3.3 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R6,17 | 47-01-102179-01 | $\begin{aligned} & \text { Res., } 22 \mathrm{~K} \Omega \pm 10 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |


| Reference <br> Designator | Ordering Number | Name and Description |
| :---: | :---: | :---: |
| R7, 11, 12 | 47-01-102108-01 | $\begin{aligned} & \text { Res., } 18 \mathrm{~K} \Omega \pm 5 \%, \\ & 1 / 4 W \end{aligned}$ |
| R8, 10,21 | 47-01-102114-01 | $\begin{aligned} & \text { Res. } \\ & 1 / 4 \mathrm{~W} \end{aligned}, 33 \mathrm{~K} \Omega \pm 5 \%,$ |
| R9 | 47-01-102106-01 | $\begin{aligned} & \text { Res., } 15 \mathrm{~K} \Omega \pm 5 \% \text {, } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R13 | 47-01-102123-01 | $\begin{aligned} & \text { Res. } \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R14 | 47-01-102116-01 | $\begin{gathered} \text { Res. }, 39 \mathrm{~K} \Omega \pm 5 \%, \\ 1 / 4 \mathrm{~W} \end{gathered}$ |
| R16,19 | 47-01-102094-01 | $\begin{aligned} & \text { Res., } 4.7 \mathrm{~K} \Omega \pm 5 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R20 | 47-01-102163-01 | $\underset{\substack{\text { Res. }, 1 / 4 W}}{ } 1 K \pm 10 \%,$ |
| R22,24 | 47-01-102101-01 | $\begin{aligned} & \operatorname{Res.,} 9.1 \mathrm{~K} \Omega \pm 5 \%, \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| R23 | 47-01-102109-01 | $\begin{aligned} & \text { Res. }, 20 \mathrm{~K} \Omega \pm 5 \%, ~ \\ & 1 / 4 \mathrm{~W} \end{aligned}$ |
| S1 | 57-02-042698-01 | Switch, slide, 4P3T |


[^0]:    Fail-Safe Protection for Output Transistors

